查询SN54LV139A供应商

捷多邦, 专业PCB打样_SN5442/4139A DUAL 2-LINE TO 4-LINE DECODERS/DEMULTIPLEXERS

 EPIC ™ (Enhanced-Performance Implanted CMOS) Process

- 2-V to 5.5-V V_{CC} Operation
- Support Mixed-Mode Voltage Operation on All Ports
- Designed Specifically for High-Speed Memory Decoders and Data-Transmission Systems
- Incorporate Two Enable Inputs to Simplify Cascading and/or Data Reception
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (D, NS), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Chip Carriers (FK), and DIPs (J)

description

The 'LV139A devices are dual 2-line to 4-line decoders/demultiplexers designed for 2-V to 5.5-V V_{CC} operation.

These devices are designed for high-performance memory-decoding or data-routing applications requiring very short propagation delay times. In high-performance memory systems, these decoders can minimize the effects of system decoding. When employed with high-speed memories utilizing a fast enable circuit, the delay time of these decoders and the enable time of the memory are usually less than the typical access time of the memory. This means that the effective system delay introduced by the decoders is negligible.

The 'LV139A devices comprise two individual 2-line to 4-line decoders in a single package. The active-low enable (\overline{G}) input can be used as a data line in demultiplexing applications. These decoders/demultiplexers feature fully buffered inputs, each of which represents only one normalized load to its driving circuit.

The SN54LV139A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74LV139A is characterized for operation from -40°C to 85°C.

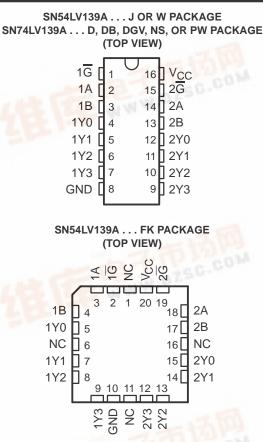


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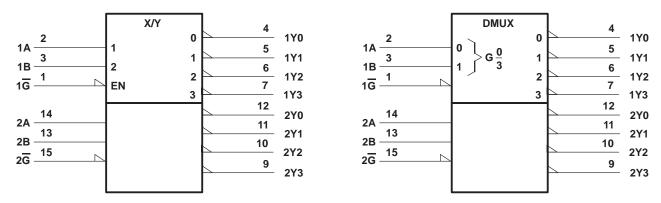


NC - No internal connection

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		FUNC		FUNCTION TABLE										
	INPUTS		OUTPUTS											
G	SEL	ECT	0017013											
G	В	Α	Y0	Y3										
н	Х	Х	Н	Н	Н	Н								
L	L	L	L	Н	Н	н								
L	L	н	н	L	Н	н								
L	н	L	н	Н	L	Н								
L	н	Н	н	Н	Н	L								

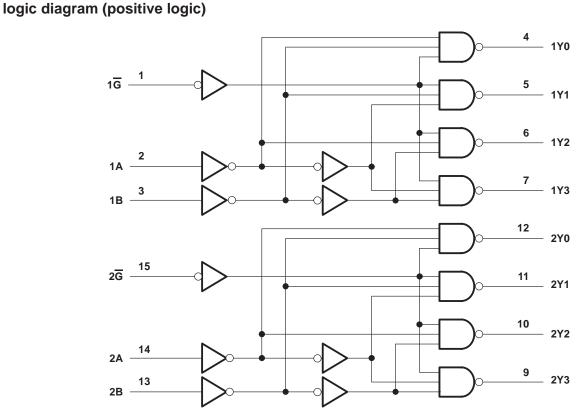
logic symbols (alternatives)[†]



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.



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Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}		–0.5 V to 7 V
Input voltage range, V _I (see Note 1)		
Voltage range applied to any output in the high	n-impedance	
or power-off state, V _O (see Note 1)		–0.5 V to 7 V
Output voltage range, V _O (see Notes 1 and 2)		–0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)		–20 mA
Output clamp current, I_{OK} (V _O < 0 or V _O > V _C	.c)	±50 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	-	±25 mA
Continuous current through V _{CC} or GND		±50 mA
Package thermal impedance, θ_{JA} (see Note 3)): D package	73°C/W
	DB package	82°C/W
	DGV package	120°C/W
	NS package	64°C/W
	PW package	108°C/W
Storage temperature range, T _{stg}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. This value is limited to 5.5 V maximum.

3. The package thermal impedance is calculated in accordance with JESD 51.



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recommended operating conditions (see Note 4)

			SN54L	V139A	SN74L	V139A	
			MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage		2	5.5	2	5.5	V
		$V_{CC} = 2 V$	1.5		1.5		
Maria		V _{CC} = 2.3 V to 2.7 V	V _{CC} × 0.7		$V_{CC} \times 0.7$		V
VIH	High-level input voltage	V _{CC} = 3 V to 3.6 V	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		v
		V _{CC} = 4.5 V to 5.5 V	V _{CC} × 0.7		$V_{CC} \times 0.7$		
		V _{CC} = 2 V		0.5		0.5	
V.		V _{CC} = 2.3 V to 2.7 V		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	V
VIL	Low-level input voltage	V _{CC} = 3 V to 3.6 V		$V_{CC} \times 0.3$			v
		V _{CC} = 4.5 V to 5.5 V		V _{CC} × 0.3		$V_{CC} \times 0.3$	
VI	Input voltage		0	J 5.5	0	5.5	V
VO	Output voltage		0	 V_{CC} 	0	VCC	V
		$V_{CC} = 2 V$	S	-50		-50	μA
1		V _{CC} = 2.3 V to 2.7 V	8	-2		-2	
ЮН	High-level output current	V _{CC} = 3 V to 3.6 V	Q.	-6		-6	mA
		V _{CC} = 4.5 V to 5.5 V		-12		-12	
		V _{CC} = 2 V		50		50	μA
1		V _{CC} = 2.3 V to 2.7 V		2		2	
IOL	Low-level output current	V _{CC} = 3 V to 3.6 V		6		6	mA
		V _{CC} = 4.5 V to 5.5 V		12		12	
		V _{CC} = 2.3 V to 2.7 V	0	200	0	200	
$\Delta t/\Delta v$	Input transition rise or fall rate	V _{CC} = 3 V to 3.6 V	0	100	0	100	ns/V
		V _{CC} = 4.5 V to 5.5 V	0	20	0	20	
ТА	Operating free-air temperature	-	-55	125	-40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics	over	recommended	operating	free-air	temperature	range	(unless
otherwise noted)					-	•	•

PARAMETER	TEST CONDITIONS		SN54	4LV139A		SN74	LV139A		UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
	I _{OH} = -50 μA	2 V to 5.5 V	V _{CC} -0.1			V _{CC} -0.1			
Vou	$I_{OH} = -2 \text{ mA}$	2.3 V	2			2			V
VOH	$I_{OH} = -6 \text{ mA}$	3 V	2.48	-		2.48			v
	I _{OH} = -12 mA	4.5 V	3.8	ĬEI,		3.8			
	I _{OL} = 50 μA	2 V to 5.5 V		EL	0.1			0.1	
Ve	$I_{OL} = 2 \text{ mA}$	2.3 V		,Q	0.4			0.4	V
VOL	$I_{OL} = 6 \text{ mA}$	3 V		5	0.44			0.44	v
	I _{OL} = 12 mA	4.5 V	00		0.55			0.55	
lį	$V_{I} = V_{CC} \text{ or } GND$	0 V to 5.5 V	40		±1			±1	μA
ICC	$V_{I} = V_{CC} \text{ or } GND, I_{O} = 0$	5.5 V			20			20	μA
l _{off}	$V_{I} \text{ or } V_{O} = 0 \text{ to } 5.5 \text{ V}$	0 V			5			5	μA
Ci	$V_{I} = V_{CC}$ or GND	3.3 V		1.9			1.9		pF



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switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T _A = 25°C		SN54L\	/139A	SN74L	UNIT		
FARAIWIETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
.	A or B	Y	C _L = 15 pF		7.7*	17.6*	1*	21*	1	21	20
^t pd	G	Y				7.4*	15.8*	1*0	19*	1	19
. .	A or B	Y	C: 50 pF		10.2	22.5	1	26.5	1	26.5	
^t pd	G	Y	C _L = 50 pF		9.9	20.2	1	24	1	24	ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO LOAD	Т	ן = 25°C	;	SN54L\	/139A	SN74L	UNIT		
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
.	A or B	Y	Ci - 15 pE		5.3*	11*	1*	1 3*	1	13	20
^t pd	G	Y	C _L = 15 pF		5.1*	9.2*	150	11*	1	11	ns
	A or B	Y	C: 50 pF		7.3	14.5	1	16.5	1	16.5	
^t pd	G	Y	C _L = 50 pF		7	12.7	1	14.5	1	14.5	ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T _A = 25°C		SN54LV	/139A	SN74L	UNIT			
FARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
	A or B	Y	C _L = 15 pF	$C_{1} = 15 \text{ pc}$		3.7*	7.2*	1*	8.5*	1	8.5	
^t pd	G	Y			3.5*	6.3*	1*0	7.5*	1	7.5	ns	
	A or B	Y	$C_{1} = 50 \text{ pF}$		5.2	9.2	< 1. 1.	10.5	1	10.5	-	
^t pd	G	Y	C _L = 50 pF		4.9	8.3	1	9.5	1	9.5	ns	

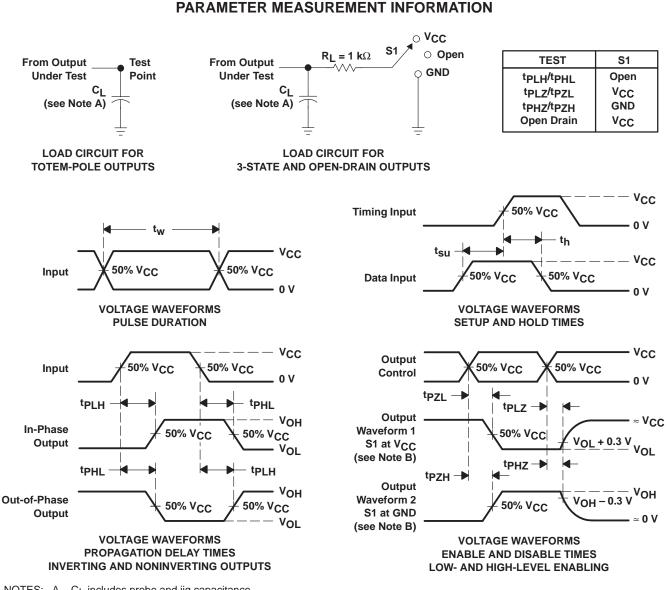
* On products compliant to MIL-PRF-38535, this parameter is not production tested.

operating characteristics, $T_A = 25^{\circ}C$

PARAMETER		TEST CO	V _{CC}	TYP	UNIT	
C _{nd} Power dissipation capacitance	$C_1 = 50 \text{pF}$	f = 10 MHz	3.3 V	17.3	pF	
Cpd	Power dissipation capacitance	CL = 50 pF,		5 V	18.2	рг



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NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_Q = 50 Ω, t_f ≤ 3 ns, t_f ≤ 3 ns.

- D. The outputs are measured one at a time with one input transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. tpHL and tpLH are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms



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